

MC56F825XE_2M53V Rev. 1, 05/2012

MC56F825x/MC56F824x (2M53V) Chip Errata

The following errata items apply to devices of the maskset 2M53V.



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23254: IIC interrupt flag (IIC_SR[IICIF]) is automatically cleared when DSC exits stop mode

Description: When address matching occurs while the IIC operates in slave receive mode, the IIC can wake the core from stop mode. However, the IICIF flag is then cleared automatically. As a result, the IIC address matching interrupt service routine cannot be entered.

Impact: Refer to the Description.

Workaround: 1. Program the IIC slave to use address matching.

- 2. Before entering stop mode, program the applicable IIC module's bit in the SIM_SD1 register to enable the module's clock to continue to operate in stop mode.
- 3. Enter stop mode.
- 4. On an address match event, an interrupt occurs and the IICIF flag remains set.



25283: RAM corruption at device reset

Description: On-chip RAM data can be corrupted if a hardware or COP reset is performed.

- Impact: User data stored in on-chip RAM can be corrupted any time that a hardware or COP reset occurs.
- **Workaround:** Store data in the flash memory used as EEPROM or in the SIM's general purpose software control registers (SIM_SCR0 SIM_SCR3), which retain data after reset.



4578: Possible incorrect readings on second ADC conversion when sampling two ADC channels and first channel input voltage < VREFL or > VREFH

- **Description:** When sampling two ADC channels that are time-consecutively listed, if the first channel input voltage is less than VREFL or greater than VREFH, incorrect readings on the second conversion may result.
- Impact: See Description.
- **Workaround:** For the ADC pins used for the conversions, ensure that the voltages are between the values VREFL + 0.1 V and VREFH 0.1 V.



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